



#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Package	I <sub>D</sub> T <sub>A</sub> = +25°C
60V	3Ω @ V <sub>GS</sub> = 10V	SOT23	310mA
600	$4\Omega$ @ $V_{GS} = 5V$	30123	270mA

### **Description**

This new generation MOSFET has been designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.





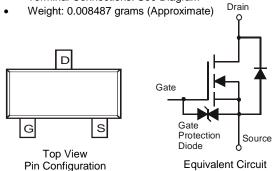
Top View

#### **Features**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- · Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 (3)
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Terminal Connections: See Diagram



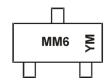
#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN65D8L-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www. www.diodes.com/products/packages.html.

# **Marking Information**



MM6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

- and dodd no												
Year	201	1	~		2016	20	17	2018		2019	2	2020
Code	Υ		~		D	E		F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMN65D8L
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# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	60	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	310 240	mA
Continuous Drain Current (Note 6) V <sub>GS</sub> = 5V	I <sub>D</sub>	270 210	mA		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	800	mA		
Maximum Body Diode Continuous Current (Note 5)	I <sub>S</sub>	500	mA		

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit	
Total Power Dissipation	(Note 6)	D	370	mW	
Total Power Dissipation	(Note 5)	P <sub>D</sub>	540		
The word Designation to Ambient	(Note 6)	-	348		
Thermal Resistance, Junction to Ambient	(Note 5)	$R_{\theta JA}$	241	°C/W	
Thermal Resistance, Junction to Case	(Note 5)	$R_{ heta JC}$	91		
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +150	°C	

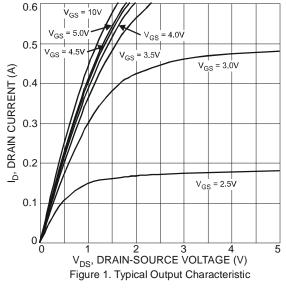
# **Electrical Characteristics** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

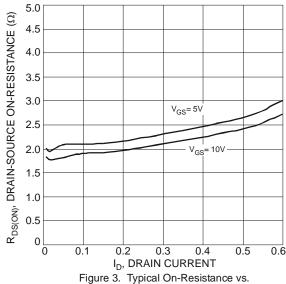
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1.0	μΑ	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Body Leakage	I <sub>GSS</sub>	_	_	±5	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.2		2.0	<b>V</b>	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance			2	3	Ω	$V_{GS} = 10V, I_D = 0.115A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	2.5	4	Ω	$V_{GS} = 5V, I_D = 0.115A$
Forward Transconductance	g <sub>FS</sub>	80	290	_	ms	$V_{DS} = 10V, I_D = 0.115A$
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C <sub>iss</sub>	_	22.0			
Output Capacitance	Coss	_	3.2		рF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	C <sub>rss</sub>	_	2.0			
Gate Resistance	Rg	_	79.9	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge V <sub>GS</sub> = 10V	Qg	_	0.87			
Total Gate Charge V <sub>GS</sub> = 4.5V	Qg	_	0.43	_	nC	$V_{GS} = 10V, V_{DS} = 30V,$
Gate-Source Charge	Q <sub>gs</sub>	_	0.11	_	nC	$I_D = 150 \text{mA}$
Gate-Drain Charge	Q <sub>qd</sub>	_	0.11	_		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	2.7	_		
Turn-On Rise Time	t <sub>R</sub>	_	2.8	_		$V_{DD} = 30V, I_D = 0.115A, V_{GEN} = 10V$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	12.6		ns	$R_{GEN} = 25\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	7.3	_		

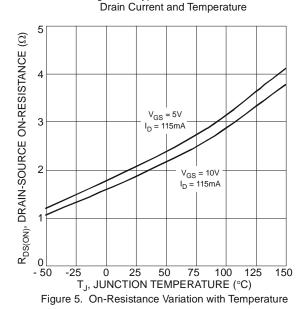
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 7 .Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing

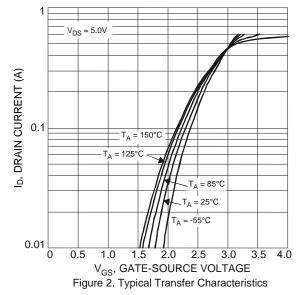
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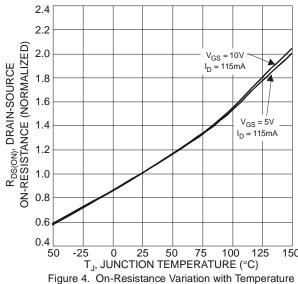








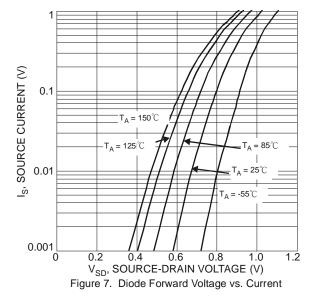




2.0 V<sub>GS(TH),</sub> GATE THRESHOLD VOLTAGE (V) 1.8 1.6  $I_D = 1mA$ 1.4 I<sub>D</sub> = 250 ℃ 1.2 1.0 0.8 0.6 0.4 0.2 50 100 125 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 6. Gate Threshold Variation vs. Ambient Temperature





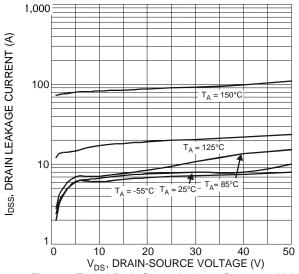
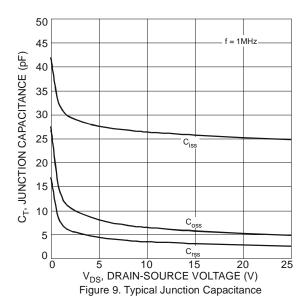


Figure 8. Typical Drain-Source Leakage Current vs. Voltage

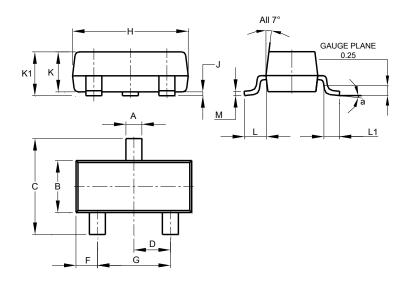




# **Package Outline Dimensions**

Please see AP02001 at http://www.diodes.com/\_files/datasheets/ap02001.pdf for the latest version.

#### SOT23

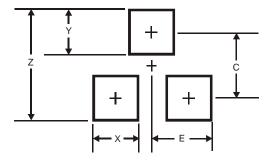


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
M	0.085	0.150	0.110				
а	8°						
All	All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/\_files/datasheets/ap02001.pdf for the latest version.

#### SOT23



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35



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